Business Purpose	X Company is committed to fulfill a service contract to its customer, Y Company. The service contract stipulates that X Company must ensure uptime of semiconductor equipment is greater than 93% to avoid financial penalties. The purpose of this training is to improve troubleshooting skills of Field Service Engineers (FSEs) to meet or exceed the uptime goal of 93%. This training prepares FSEs in the semiconductor industry to troubleshoot			
	complex manufacturing problems. Successful front-line troubleshooting ultimately leads to reduced equipment downtime, minimized escalations to advanced support, and positive effects on the bottom line.			
Target Audience	Junior FSEs with little to no troubleshooting experience, geographically distributed across different countries/times zones			
Training Time	20 minutes			
Training Recommendation	1 training module developed in Articulate Rise			
	Self-paced and responsive on different devices			
	Ease of use for geographically disbursed audience			
	Agile for content updates			
	Job aids for quick reference			
Deliverables	• 1 Rise course, including:			
	Scenario-based learning woven throughout module			
	 Interactive troubleshooting process flowchart developed in Articulate Storyline 			
	Elearning Assessment			
	 Knowledge checks 			
	o Final Quiz			
	2 downloadable Job Aids			
	 Troubleshooting Process Flow Chart PDF 			
	 Action Plan Considerations Infographic PDF 			
Learning Objectives	After this training, FSEs will be able to:			
	Outline the steps of the troubleshooting process.			
	Identify the elements of a detailed problem statement.			
	Explain how to develop an action plan.			
	Describe the components of a post-mortem.			
Training Outline	Course Introduction			
	 Learning Objectives 			
	Overview of Troubleshooting Process			
	 Troubleshooting Process Flow Chart 			
	 Create and/or confirm the problem statement. 			

Design Document: Troubleshooting Skills in Semiconductor Manufacturing

	٠	Create a problem statement.
		Confirm the initial problem statement, if one is already written.
		May need to rewrite the problem statement after gathering more information during the investigation phase.
• C	Confirm	the tool conditions.
	•	Confirm the tool conditions:
	•	What is the abnormality?
	•	When, where, and for how long has
		the problem occurred?
	•	What is the impact?
	•	What is the urgency?
- Δ	Analyze	applicable data.
	•	Analyze:
	•	Current knowledge of the problem
	•	Physical observation
		Any relevant data logs.
• D	Determi	ine the model.
		Determine which model(s) are involved in the issue to create the action plan.
• C	Create t	he action plan(s).
		Write the action plans(s), based on the models previously identified.
• E	xecute	the action plan(s).
	•	Implement or execute the action plan.
	•	Now you get to try to fix the problem!
• C	Confirm	the action plan(s) results.
		Confirm whether the action plan resolved the issue by direct observation and analyzing the data again.
• If	f neede	d, develop new action plans.
		Was the criteria met? Inform the appropriate parties of the results.
		If the criteria was not met, create and/or implement new action plans.
- V	Vrite a	post-mortem.

Design Document: Troubleshooting Skills in Semiconductor Manufacturing

 Knowledge Check 			
Phase 1: Investigation			
 Scenario: Investigating a Tool Issue 			
 Scenario: Confirming the Problem Statement and the Tool Conditions 			
 Analyze Applicable Data 			
 Knowledge Check 			
Phase 2: Action Plan			
 Scenario: Determining the Model 			
 Action Plan Considerations 			
 Scenario: Executing the Action Plan and Confirming the Action Plan Results 			
 Knowledge Check 			
Phase 3: Post-Mortem			
 Elements of a Post-Mortem 			
 Scenario: Writing a Post-Mortem 			
 Knowledge Check 			
Assessment:			
 5 graded questions of varied type, each assessing a different learning objective 			
 (LO1: Outline the steps of the troubleshooting process.) Match the step number with its corresponding step in the troubleshooting process. 			
 (LO2: Identify the elements of a detailed problem statement.) Choose the best response(s) to the question. There may be more than one correct response. What are some elements of a detailed problem statement? 			
 (LO2: Identify the elements of a detailed problem statement.) Which of the following questions are necessary to answer to create an accurate, detailed problem statement? Select all that apply. 			
 (LO3: Explain how to develop an action plan.) Select the best answer to the question. What must be determined before developing an action plan? 			
 (LO4: Describe the components of a post- mortem.) What are the main components of a post-mortem? Choose the best answer. 			
 Allows unlimited attempts 			

Design Document: Troubleshooting Skills in Semiconductor Manufacturing

	Summary		
	Through examining the phases and steps of the troubleshooting flow chart and experiencing a real-life troubleshooting scenario, you can now apply the troubleshooting skills you have learned to solve complex tool issues in the fab.		
	Course Completion: congratulations		
Assessment Plan	Ungraded knowledge checks with feedback after each main topic		
	Graded final quiz with feedback after quiz		
	 Questions of varied type aligned with learning objectives 		
	 Must score 80% or better to pass; unlimited attempts 		